

### **DATASHEET**

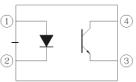
## **4 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER EL816 Series**







### Schematic

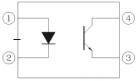


#### Features:

- Compliance Halogens Free (Only copper leadframe) (Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)
- Current transfer ratio

(CTR:  $50\sim600\%$  at  $I_F = 5mA$ ,  $V_{CE} = 5V$ ) (CTR:  $63\sim320\%$  at  $I_F = 10mA$ ,  $V_{CF} = 5V$ )

- High isolation voltage between input and output (Viso=5000Vrms)
- Creepage distance > 7.62mm
- Operating temperature up to +110°C
- · Compact small outline package
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- UL and cUL approved(No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved



### Pin Configuration

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector

### Description

The EL816 series of devices each consist of an infrared emitting diodes, optically coupled to a phototransistor detector.

They are packaged in a 4-pin DIP package and available in wide-lead spacing and SMD option.

### **Applications**

- Programmable controllers
- · System appliances, measuring instruments
- Telecommunication equipments
- Home appliances, such as fan heaters, etc.
- Signal transmission between circuits of different potentials and impedances



### **Absolute Maximum Ratings (Ta=25°C)**

	Parameter	Symbol	Rating	Unit
	Forward current	I <sub>F</sub>	60	mA
	Peak forward current (1us, pulse)	I <sub>FP</sub>	1	А
Input	Reverse voltage	$V_R$	6	V
	Power Dissipation  No derating required up to $T_a = 100^{\circ}C$	$P_{D}$	100	mW
	Power dissipation	D	150	mW
	Derating factor (above $T_a = 80^{\circ}C$ )	P <sub>C</sub> —	5.8	mW/°C
Output	Collector current	I <sub>C</sub>	50	mA
	Collector-Emitter voltage	$V_{\sf CEO}$	80	V
	Emitter-Collector voltage	V <sub>ECO</sub>	6	V
Total Powe	er Dissipation	P <sub>TOT</sub>	200	mW
Isolation V	oltage*1	$V_{ISO}$	5000	Vrms
Operating	Temperature	T <sub>OPR</sub>	-55 to 110	°C
Storage Te	emperature	T <sub>STG</sub>	-55 to 125	°C
Soldering	Temperature* <sup>2</sup>	T <sub>SOL</sub>	260	°C

#### Notes:

 $<sup>^*1</sup>$  AC for 1 minute, R.H.=  $40 \sim 60\%$  R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

<sup>\*2</sup> For 10 seconds



### Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	$V_{F}$	-	1.2	1.4	V	$I_F = 20 \text{mA}$
Reverse Current	I <sub>R</sub>	-	-	10	μΑ	V <sub>R</sub> = 4V
Input capacitance	C <sub>in</sub>	-	30	250	рF	V = 0, f = 1kHz

Output

Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Emitter dark	I <sub>CEO</sub>	-	-	100	nA	$V_{CE} = 20V, I_F = 0mA$
current	020					
Collector-Emitter	$BV_CEO$	80	_	_	V	$I_{\rm C} = 0.1  \rm mA$
breakdown voltage	D 4 CEO	00			•	16 = 0.111171
Emitter-Collector	$BV_ECO$	6	_	_	V	I <sub>E</sub> = 0.1mA
breakdown voltage	PAECO	0	_		v	ie – O. IIIIA

**Transfer Characteristics** 

Param	eter	Symbol	Min	Тур.	Max.	Unit	Condition
	EL816	CTR	50	-	600	- - - % -	$I_F = 5 \text{mA}$ , $V_{CE} = 5 \text{V}$
	EL816A		80	-	160		
	EL816B		130	-	260		
	EL816C		200	-	400		
	EL816D		300	-	600		
Current Transfer ratio	EL816X		100	-	200		
	EL816Y		150	-	300		
	EL816I	- - CTR -	63	-	125		$I_F = 10 \text{mA}, V_{CE} = 5 \text{V}$
	EL816J		100	-	200		
	EL816K		160	-	320	0/	
	EL816I		22	-	-	%	$I_F = 1 \text{mA}$ , $V_{CE} = 5 \text{V}$
	EL816J		34	-	-		
	EL816K		56	-	-		



### Transfer Characteristics (T<sub>a</sub>=25°C unless specified otherwise) Continuity

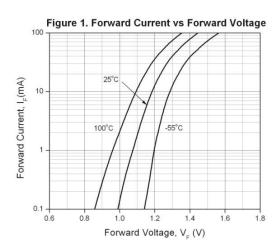
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Emitter saturation voltage	$V_{\text{CE(sat)}}$	-	0.1	0.2	V	$I_F = 20 \text{mA}, I_C = 1 \text{mA}$
Isolation resistance	R <sub>IO</sub>	5×10 <sup>10</sup>	-	-	Ω	V <sub>IO</sub> = 500Vdc, 40~60% R.H.
Floating capacitance	$C_{IO}$	-	0.6	1.0	pF	$V_{IO} = 0$ , $f = 1MHz$
Cut-off frequency	fc	-	80	-	kHz	$V_{CE} = 5V$ , $I_C = 2mA$ $R_L = 100\Omega$ , -3dB
Rise time	t <sub>r</sub>	-	4	18	μs	$V_{CE} = 2V$ , $I_C = 2mA$ ,
Fall time	t <sub>f</sub>	-	3	18	μs	$R_L = 100\Omega$

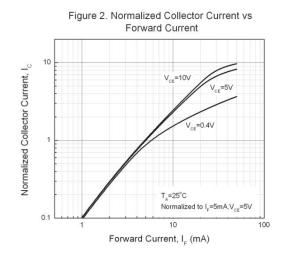
<sup>\*</sup> Typical values at T<sub>a</sub> = 25°C

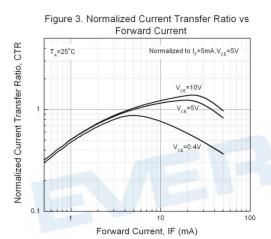


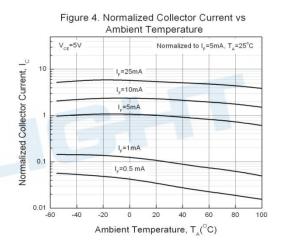


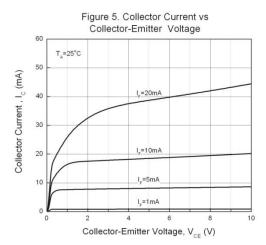
### **Typical Electro-Optical Characteristics Curves**

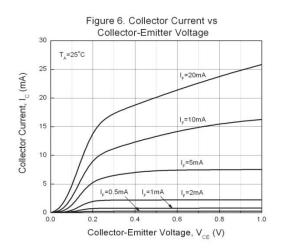




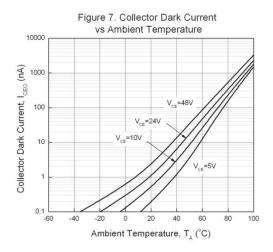


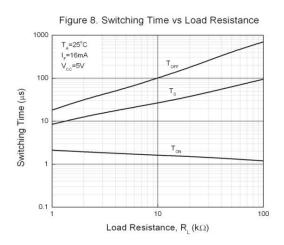


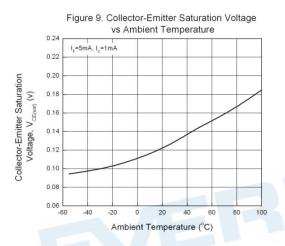












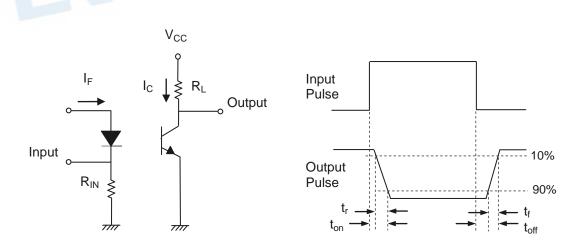


Figure 10. Switching Time Test Circuit & Waveforms



### **Order Information**

#### **Part Number**

# **EL816X(Y)(Z)-FV**

#### Note

X = Lead form option (S1, S2, M or none)

Y = CTR Rank (A, B, C, D, X, Y, I, J, K or none)

Z = Tape and reel option (TU, TD or none).

F = Lead frame option (F: Iron, None: copper)

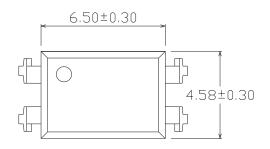
V = VDE safety (optional).

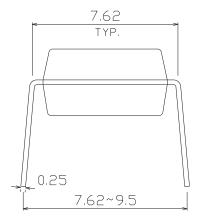
Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
М	Wide lead bend (0.4 inch spacing)	100 units per tube
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel
S2 (TU)	Surface mount lead form (low profile) + TU tape & reel option	2000 units per reel
S2 (TD)	Surface mount lead form (low profile) + TD tape & reel option	2000 units per reel

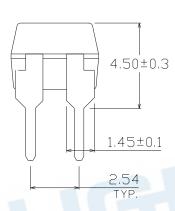


### Package Dimension (Dimensions in mm)

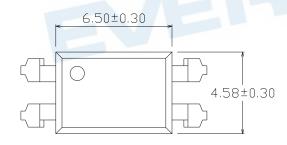
### **Standard DIP Type**

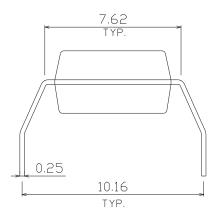


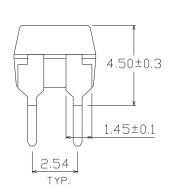




### **Option M Type**

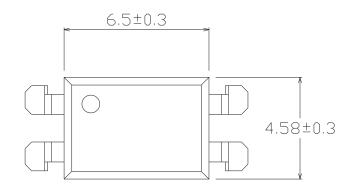


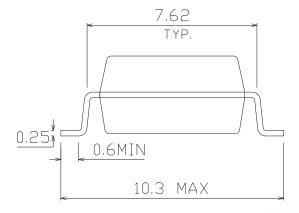


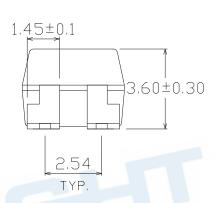




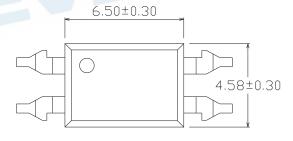
### **Option S1 Type**

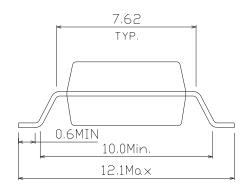


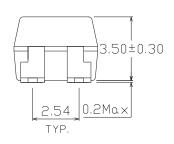




### **Option S2 Type**

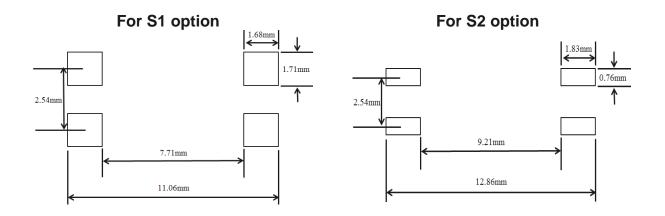




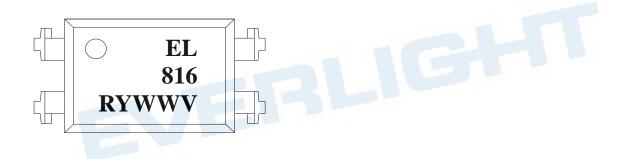




### Recommended pad layout for surface mount leadform



### **Device Marking**



#### **Notes**

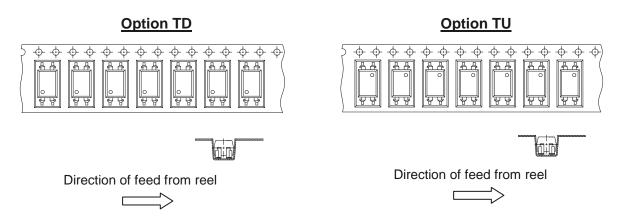
EL denotes EVERLIGHT 816 denotes Device Number

R denotes CTR Rank(A, B, C, D, X, Y, I, J, K or none)

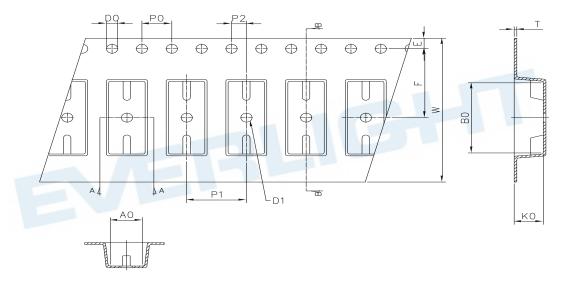
Y denotes 1 digit Year code WW denotes 2 digit Week code V denotes VDE (optional)



**Tape & Reel Packing Specifications** 



### **Tape dimensions**



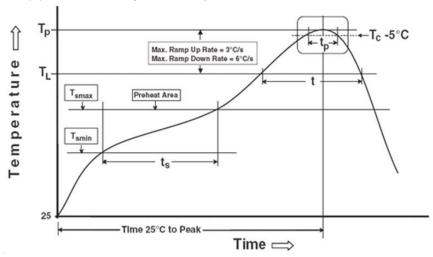
Dimension No.	Ao	Во	Do	D1	E	F
Dimension (mm) S1	4.90±0.1	10.40±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.50±0.1
Dimension (mm) S2	4.88±0.1	12.55±0.1	1.5±0.1	1.50±0.1	1.75±0.1	11.5±0.1
Dimension No.	Ро	P1	P2	t	w	Ко
Dimension No.  Dimension (mm)  S1	Po 4.00±0.1	P1 8.00±0.	P2 2.00±0.1	t 0.40±0.1	<b>W</b> 16.00±0.3	<b>Ko</b> 4.60±0.1



### **Precautions for Use**

### 1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

#### **Preheat**

Temperature min (T<sub>smin</sub>)

Temperature max (T<sub>smax</sub>)

Time ( $T_{smin}$  to  $T_{smax}$ ) ( $t_s$ )

Average ramp-up rate (T<sub>smax</sub> to T<sub>p</sub>)

### Other

Liquidus Temperature (T<sub>L</sub>)

Time above Liquidus Temperature (t<sub>1</sub>)

Peak Temperature (T<sub>P</sub>)

Time within 5 °C of Actual Peak Temperature: T<sub>P</sub> - 5°C

Ramp- Down Rate from Peak Temperature

Time 25°C to peak temperature

Reflow times

Reference: IPC/JEDEC J-STD-020D

150 °C

200°C

60-120 seconds

3 °C/second max

217 °C

60-100 sec

260°C

30 s

6°C /second max.

8 minutes max.

3 times



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